



# SPN65T10

## N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPN65T10 is the N-Channel enhancement mode power field effect transistor which is produced using high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suitable for synchronous rectifier application, Motor control power management and other Power Tool circuits. It has been optimized for low gate charge, low  $R_{DS(ON)}$  and fast switching speed.

### FEATURES

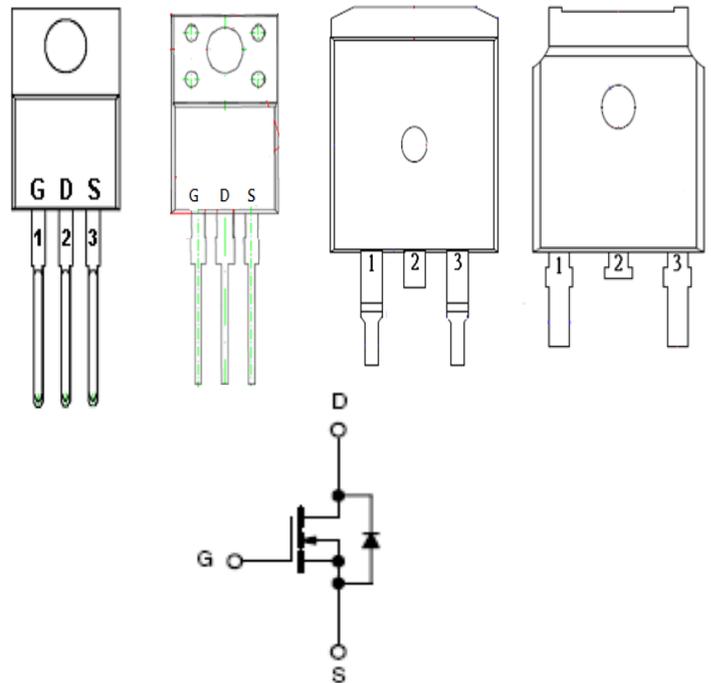
- ◆ 100V/68A,  $R_{DS(ON)}=14m\Omega@V_{GS}=10V$
- ◆ Super high density cell design for extremely low  $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-220-3L/TO-220F-3L/TO-263-2L/TO-252-2L package design

### APPLICATIONS

- DC/DC Converter
- Load Switch
- SMPS Secondary Side Synchronous Rectifier
- Power Tool
- Motor Control

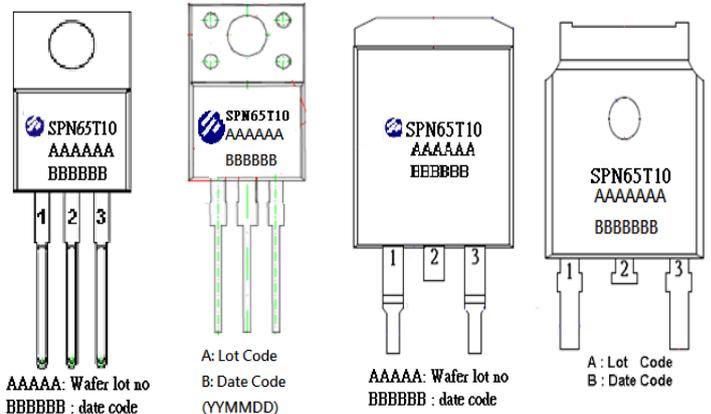
### PIN CONFIGURATION

TO-220-3L TO-220F-3L TO-263-2L TO-252-2L



### PART MARKING

TO-220-3L TO-220F-3L TO-263-2L TO-252-2L





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### PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPN65T10T220TGB	TO-220-3L	SPN65T10
SPN65T10T220FTGB	TO-220F-3L	SPN65T10
SPN65T10T262RGB	TO-263-2L	SPN65T10
SPN65T10T252RGB	TO-252-2L	SPN65T10

- ※ SPN65T10T220TGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN65T10T220FTGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN65T10T262RGB : Tape&Reel ; Pb – Free ; Halogen - Free
- ※ SPN65T10T252RGB : Tape&Reel ; Pb – Free ; Halogen - Free

### ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	100	V
Gate –Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current(T <sub>J</sub> =150°C)	I <sub>D</sub>	TA=25°C	68
		TA=70°C	45
Pulsed Drain Current	I <sub>DM</sub>	260	A
Power Dissipation@ Tc=25°C	P <sub>D</sub>	TO-220/TO-263	104
Power Dissipation@ Tc=25°C		TO-220F/TO-252	93
Avalanche Energy with Single Pulse ( T <sub>j</sub> =25°C , L = 0.1mH , I <sub>D</sub> = 23A , V <sub>DS</sub> =100V. )	E <sub>AS</sub>	171	mJ
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Case (TO-220/TO-220F/TO-263)	R <sub>θJC</sub>	1.2	°C/W
Thermal Resistance-Junction to Case (TO-252)	R <sub>θJC</sub>	1.35	°C/W



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### ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

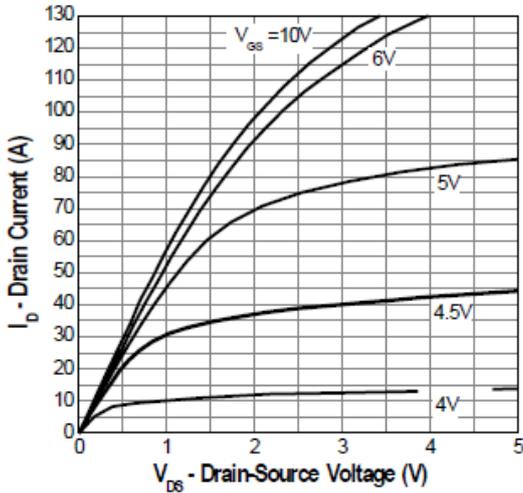
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	100			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	V
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=80V, V_{GS}=0V$			10	uA
		$V_{DS}=80V, V_{GS}=0V$ $T_J=150^\circ C$			100	
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=45A$			14	mΩ
Diode Forward Voltage	$V_{SD}$	$I_S=45A, V_{GS}=0V$			1.3	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=80V, V_{GS}=4.5V$ $I_D=30A$		57		nC
Gate-Source Charge	$Q_{gs}$			12		
Gate-Drain Charge	$Q_{gd}$			17.5		
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V$ $f=1MHz$		2920		pF
Output Capacitance	$C_{oss}$			261		
Reverse Transfer Capacitance	$C_{rss}$			162		
Turn-On Time	$t_{d(on)}$	$V_{DD}=50V, R_L=1.6\Omega$ $I_D=30A, V_{GEN}=10V$ $R_G=10\Omega$		15		nS
	$t_r$			13		
Turn-Off Time	$t_{d(off)}$			55		
	$t_f$			21		



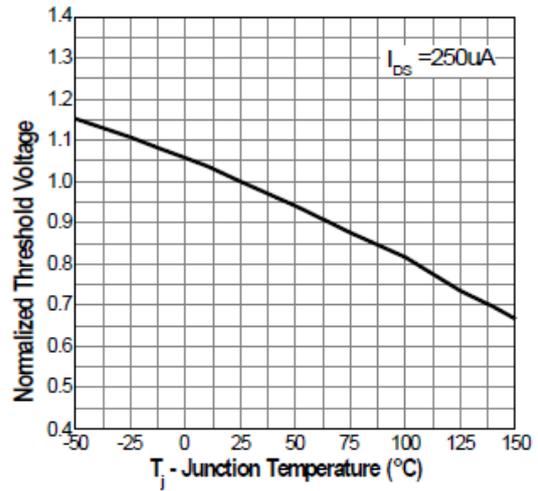
# SPN65T10 N-Channel Enhancement Mode MOSFET

## TYPICAL CHARACTERISTICS

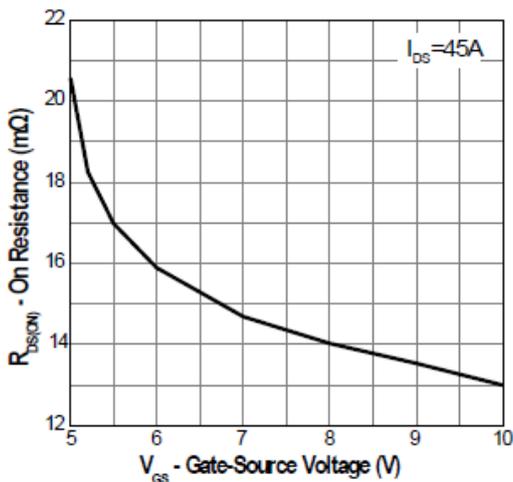
### Output Characteristics



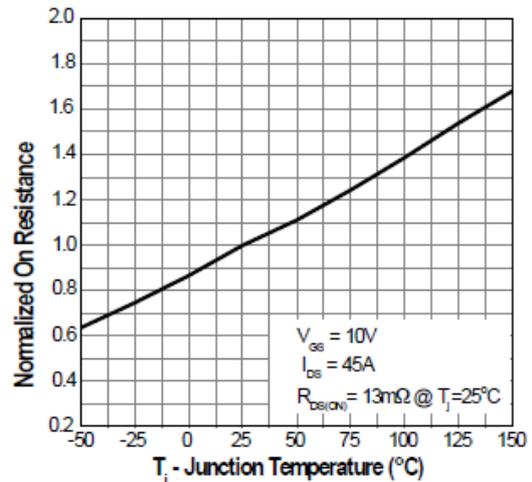
### Gate Threshold Voltage vs. Temperature



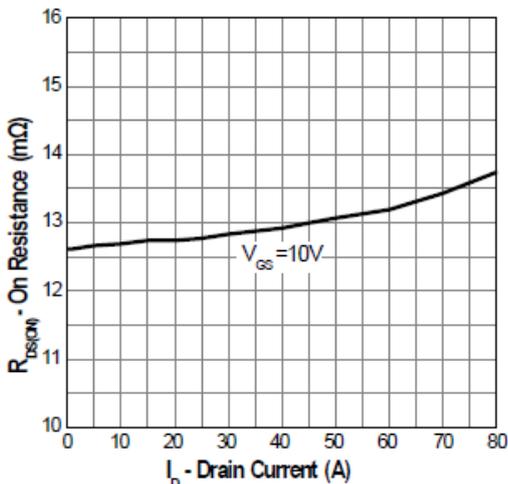
### On-Resistance vs. Gate-Source Voltage



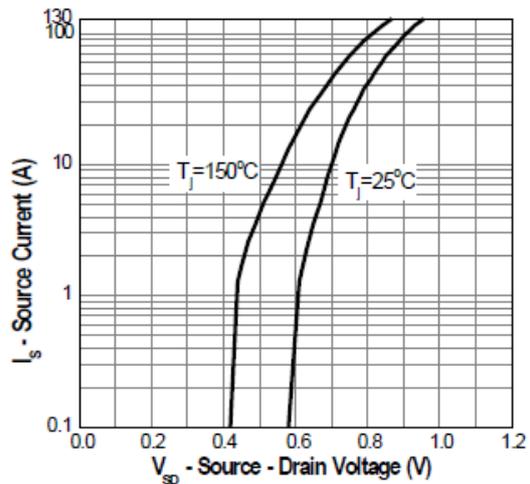
### On-Resistance vs. Temperature



### On-Resistance vs. Drain Current



### Source-Drain Diode Forward Characteristics

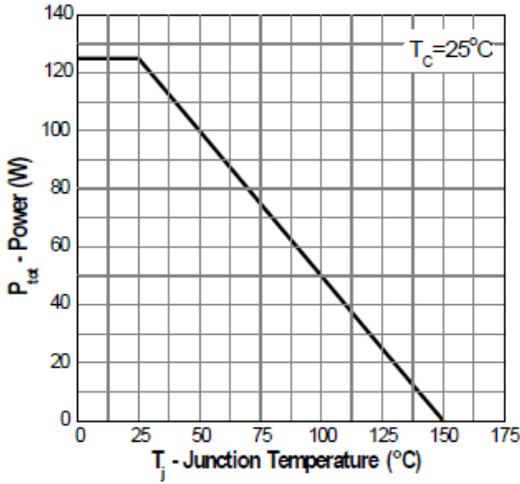




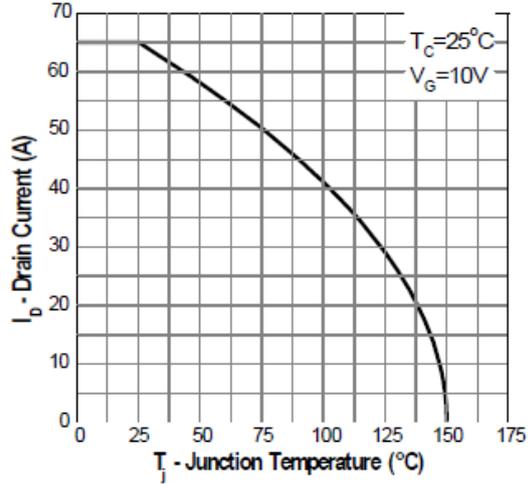
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## TYPICAL CHARACTERISTICS

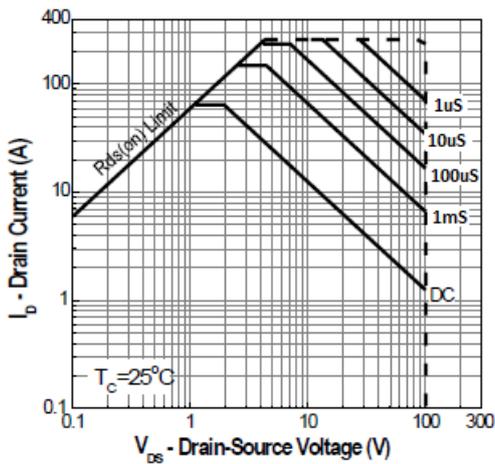
### Power Dissipation



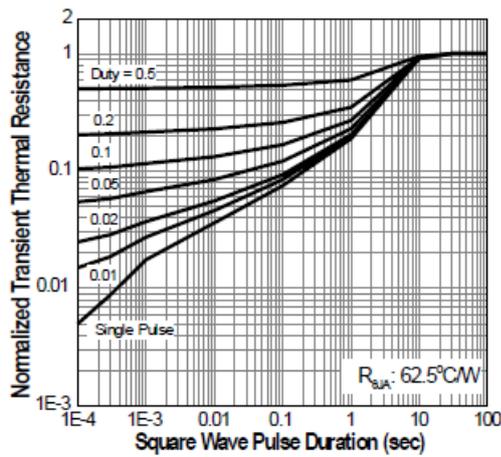
### Drain Current vs. Temperature



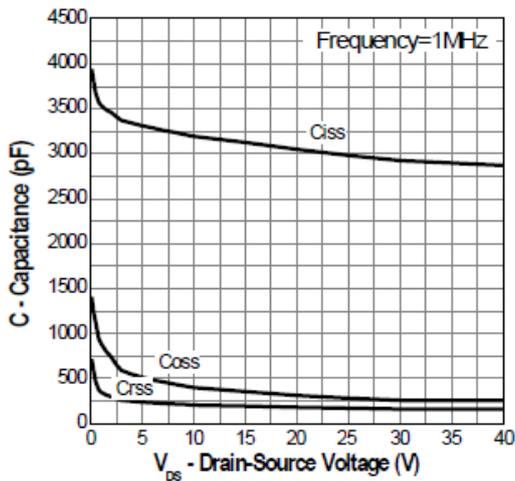
### Safe Operation Area



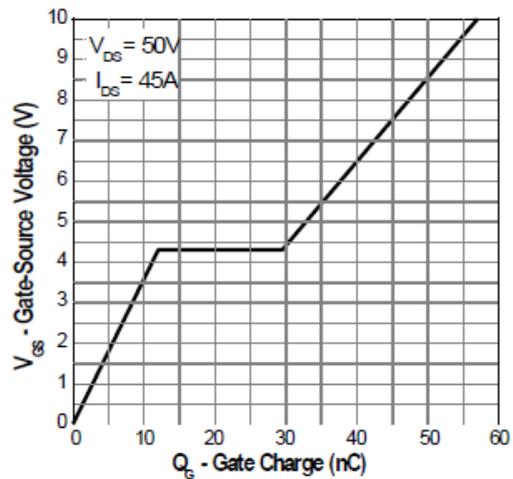
### Transient Thermal Impedance



### Capacitance Characteristics



### Gate-Charge Characteristics





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